

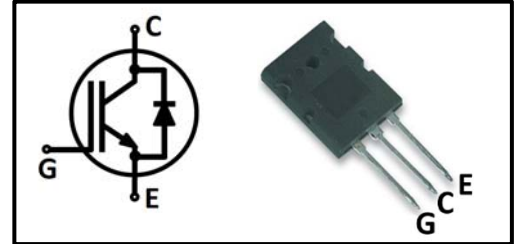
## Features

- Easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Low  $V_{CEsat}$ , fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

Type	Marking	Package Code
MPBL50N120B	MP50N120B	TO-264

## Applications

- Welding Machine
- UPS



## Maximum Rated Values

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CE}$	1200	V
DC collector current, limited by $T_{jmax}$ $T_C=25^\circ\text{C}$ $T_C=100^\circ\text{C}$	$I_C$	100 50	A
Pulsed collector current, $t_p$ limited by $T_{jmax}^{1)}$	$I_{Cpuls}$	200	
Diode forward current, limited by $T_{jmax}$ $T_C=25^\circ\text{C}$ $T_C=100^\circ\text{C}$	$I_F$	50 25	
Diode pulsed current, $t_p$ limited by $T_{jmax}^{1)}$	$I_{Fpuls}$	100	
Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}, D < 0.01$ )		$\pm 30$	
Power dissipation $T_C=25^\circ\text{C}$	$P_{tot}$	535	W
Power dissipation $T_C=100^\circ\text{C}$		267	
Operating junction temperature	$T_j$	-40~175	°C
Storage temperature	$T_{stg}$	-55~150	
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	
Mounting torque, M3 screw Maximum of mounting processes: 3	M	0.6	Nm

<sup>1)</sup> Defined by design. Not subject to production test.



### Thermal Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
IGBT thermal resistance, junction-case	$R_{thJC}$	-	-	0.28	K/W
Diode thermal resistance, junction-case	$R_{thJCD}$	-	-	0.80	
Thermal Resistance, junction-ambient	$R_{thJA}$	-	-	30	

### Electrical Characteristics (at $T_j=25^\circ\text{C}$ , unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=0.25mA$	1200	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=50A$ $T_j=25^\circ\text{C}$	-	1.90	2.30	
		$T_j=150^\circ\text{C}$	-	2.50	-	
		$T_j=175^\circ\text{C}$	-	2.65	-	
Diode forward voltage	$V_F$	$V_{GE}=0V, I_F=25A$ $T_j=25^\circ\text{C}$	-	2.0	-	
		$T_j=150^\circ\text{C}$	-	1.7	-	
		$T_j=175^\circ\text{C}$	-	1.6	-	
G-E threshold voltage	$V_{GE(th)}$	$I_C=1.7mA, V_{CE}=V_{GE}$	5.0	5.8	6.5	
C-E leakage current	$I_{CES}$	$V_{CE}=1200V,$ $V_{GE}=0V$ $T_j=25^\circ\text{C}$	-	-	0.1	mA
		$T_j=175^\circ\text{C}$	-	-	4.0	
G-E leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	-	-	250	nA

### Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input capacitance	$C_{ies}$	$V_{CE}=25V,$ $V_{GE}=0V,$ $f=1MHz$	-	6050	-	pF
Output capacitance	$C_{oes}$		-	145	-	
Reverse transfer capacitance	$C_{res}$		-	135	-	
Gate charge	$Q_G$	$V_{CC}=600V, I_C=50A,$ $V_{GE}=15V$	-	480	-	nC



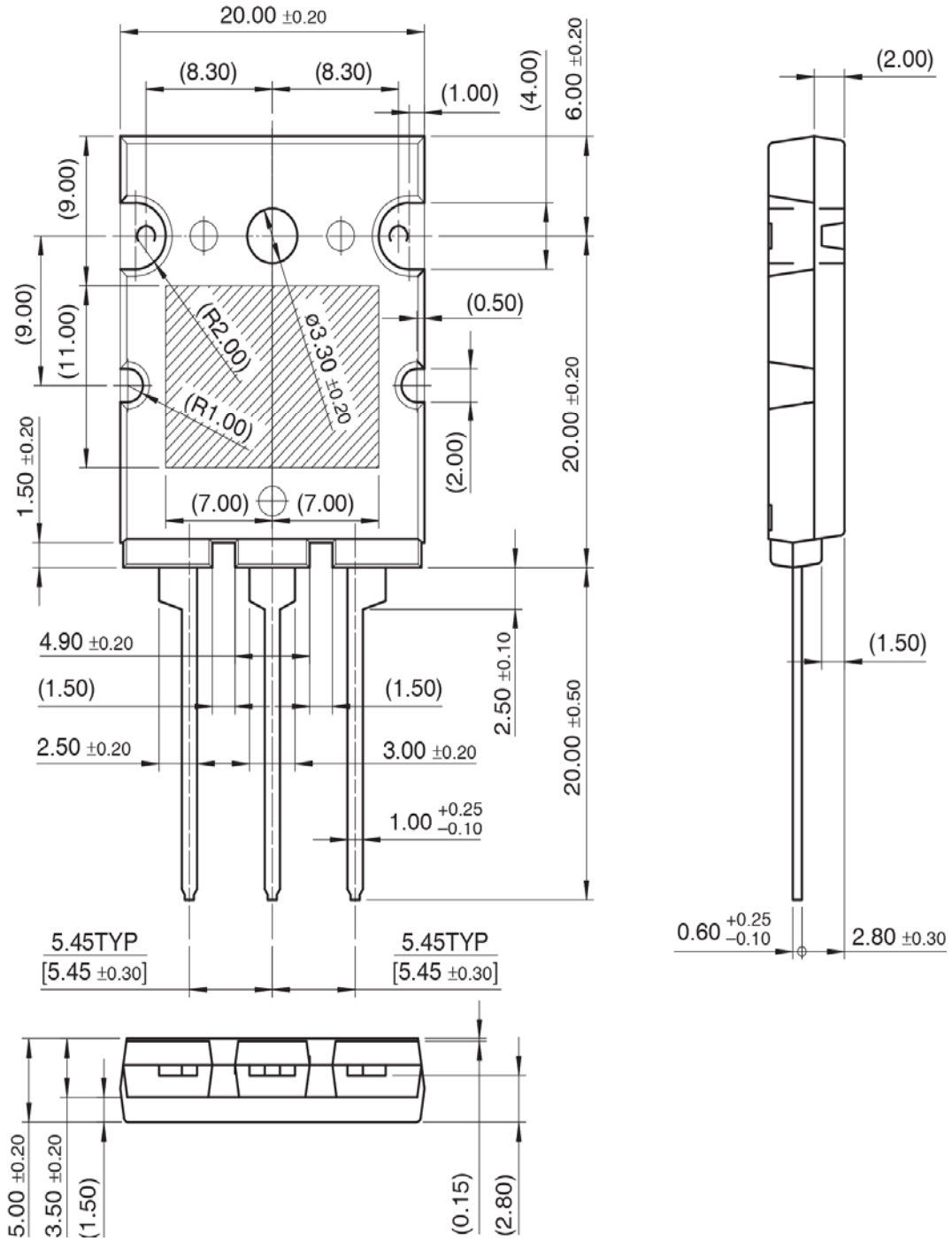
### IGBT Switching Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit	
Turn-on delay time	$t_{d(on)}$	$T_j=25^{\circ}\text{C}$ , $V_{CC}=600\text{V}$ , $I_C=50\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	92	-	ns	
Rise time	$t_r$		-	156	-		
Turn-off delay time	$t_{d(off)}$		-	622	-		
Fall time	$t_f$		-	72	-		
Turn-on energy	$E_{on}$		Inductive load	-	6.68	-	mJ
Turn-off energy	$E_{off}$			-	3.07	-	
Total switching energy	$E_{ts}$			-	9.75	-	
Turn-on delay time	$t_{d(on)}$	$T_j=175^{\circ}\text{C}$ , $V_{CC}=600\text{V}$ , $I_C=50\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	81	-	ns	
Rise time	$t_r$		-	146	-		
Turn-off delay time	$t_{d(off)}$		-	723	-		
Fall time	$t_f$		-	96	-		
Turn-on energy	$E_{on}$		Inductive load	-	6.84	-	mJ
Turn-off energy	$E_{off}$			-	4.10	-	
Total switching energy	$E_{ts}$			-	10.94	-	

### Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode reverse recovery time	$t_{rr}$	$T_j=25^{\circ}\text{C}$ , $V_R=600\text{V}$ , $I_F=25\text{A}$ , $di_F/dt=300\text{A}/\mu\text{s}$	-	230	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	1.72	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	16.0	-	A
Diode reverse recovery time	$t_{rr}$	$T_j=175^{\circ}\text{C}$ , $V_R=600\text{V}$ , $I_F=25\text{A}$ , $di_F/dt=300\text{A}/\mu\text{s}$	-	392	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	4.25	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	25.6	-	A

TO-264





## Revision History

Revision	Subjects (major changes since last revision)	Date
1.0	Initial version	2021.8

## Terms & Conditions of usage

1. The product specifications, characteristics, data, materials and structures given in this datasheet are subject to change without notice.
2. The information given in this datasheet shall in no event be regarded as a guarantee of conditions or characteristics. Marching-Power Technology Co., Ltd. does not warrant or assume any legal liability or responsibility for the accuracy and completeness of any examples, hints or any typical values stated herein and/or any information regarding the application of the product.
3. This datasheet is only used as a reference for customers to apply our products, Marching-Power Technology Co., Ltd. does not undertake to permit the use of intellectual property rights or any third-party property rights related to the product information described in this datasheet.
4. Although Marching-Power Technology Co., Ltd. is committed to enhancing product quality and reliability, all semiconductor products still have a probability of failure. When using Marching-Power semiconductor products in your equipment, you are requested to take adequate safety measures to prevent the equipment from causing accidents or events including but not limited to physical injury, fire or damage to other property if any of the products become faulty.
5. The products introduced in this datasheet are electrostatic sensitive devices and must be protected against static electricity during device installation, testing, packaging, storage and transportation.
6. Do not use the products introduced in this datasheet in equipment or systems that requiring strict reliability or/and may directly endanger human life such as medical, life-saving, life-sustaining, space equipment, aeronautic equipment, nuclear equipment submarine repeater equipment and equivalents to strategic equipment (without limitation).
7. No part of this datasheet may be disseminated and reproduced in any form or by any means without prior written permission from Marching-Power Technology Co., Ltd.
8. The data contained in this datasheet is exclusively intended for use by professional technicians only. It is the responsibility of the customer's own technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to corresponding application. If you have any question about any portion in this datasheet, contact Marching-Power Technology Co., Ltd. before using the product. Marching-Power Technology Co., Ltd. shall not be liable for any injury caused by any use of the products not in accordance with instructions set forth herein.